

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Hans-Jurgen Albrecht, et al.	:	Examiner: S.J. Cohen
)	
Application No.: 10/554,274	:	Group Art No.: 1793
)	
Filed: September 13, 2006	:	Confirmation No.: 3094
)	
For: SOLDERING MATERIAL BASED ON Sn	:	
Ag AND Cu	:	October 5, 2009

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed June 4, 2009,
a response to which having been extended for a period of time of
one (1) month by the accompanying Petition Under 37 C.F.R. §
1.136(a) and fee, kindly amend the subject application as
follows.

Amendments to the claims begin on page 2 of this
paper.

Remarks begin on page 4 of this paper.